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Paper

Raman Study of Laser Induced Heating Effects in Free-Standing Silicon Nanocrystals

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This paper demonstrates that free-standing silicon nanocrystals (Si NCs) have significant different thermal conductivity properties compared to Si NCs embedded in a host matrix. The temperatures of Si NCs under laser illumination have been determined by measuring the ratio of the Anti-Stokes-to-Stokes intensities of the first order Si-Si transverse optical (TO) phonon mode. It is found that the large free-standing Si NCs are easily heated up to ~953 K by the laser light. The laser heating effects are reversible to a large extent, however the nature of the free-standing Si NCs is slightly modified after intensive illumination. The free-standing Si NCs can even be easily melted when exposed to a well-focused laser beam. Under these conditions, the blackbody radiation of the heated Si NCs starts to compete with the detected Raman signals. A simplified model of the heating effects is proposed to study the size dependence of the heated free-standing Si NCs with increasing laser power. It is concluded that the huge red-shift of the Si-Si TO mode observed under intensive laser illumination originates from the laser induced heating effects. In contrast, under similar illumination conditions the Si NCs embedded in matrixes are hardly heated due to better thermal conductivity.

Introduction

Nanocrystals (NCs), also called as quantum dots (QDs), exhibit unique physical, mechanical and electrical properties since their excitons are confined in all three spatial dimensions.^{1, 2} NCs made of variety of direct and indirect semiconductor materials, have promising applications in the novel designs of light emitting diodes (LED),³ batteries,⁴ solar cells^{5, 6} and water splitting devices.⁷ For example, NCs might open routes to new photovoltaic (PV) concepts conquering the Shockley-Queisser limit⁸ of single junction solar cell devices, using mechanisms like multiple exciton generation (MEG)⁹ and down conversion by space separated quantum cutting (SSOC).¹⁰ In this contribution we focus on NCs based on silicon (Si), which is the most dominant material in semiconductor industry due to its abundance, relatively low cost processing and resistance against water.5, 11-15 These Si NCs can be either free-standing or embedded in a host matrix, such as amorphous silicon carbide (a-SiC:H), amorphous silicon (a-Si:H) and amorphous silicon oxide (a-SiO_x:H).

The bandgap of the Si NCs has a strong dependence on the size of NCs. However, the characterization of the size distribution of the ensembles of Si NCs is a challenge. For instance, scanning electron microscopy (SEM) is a direct way to observe the morphology of either the surface or the cross-section of ensembles of NCs. However, the extent of magnification is limited to establish a clear observation of a single NC with a diameter of a few nanometers (nm). High resolution

transmission electron microscopy (HR-TEM) has a higher resolution and can even be utilized to investigate the lattice in the grains,^{5, 6} but it's more expensive in maintenance and more complex in preparing the samples for characterization. Especially when the Si NCs are embedded in a solid matrix, the quality of the final images is very sensitive to the ion-beampreparation. thinning technique during the sample Photoluminescence (PL) is also a popular way to estimate the diameter (d) of small (2 nm < d < 10 nm) Si NCs.¹⁶ This technique monitors the radiative recombination of light-excited charge carriers to determine the bandgap energy and consequently the average size of the NCs. A shortcoming of PL on NCs is that indirect bandgap materials have a poor radiative recombination and that the Shockley-Read-Hall (SRH) recombination at defect-rich surfaces or interfaces competes with radiative recombination.¹⁷⁻¹⁹ These effects result in a rather low PL intensity from indirect bandgap materials such as Si, compared to direct bandgap semiconductors in the III-V group.^{20, 21} X-Ray diffraction (XRD) is another good tool for the size estimation according to Scherrer formula,²² but it only works accurate on highly crystallized small NCs.

In this work, we focus on Raman spectroscopy (RS), which can be assumed as a comparatively cheap, fast and easy-to-operate characterization tool utilized for monitoring the crystallinity of the material. The mono-crystalline silicon (c-Si) wafer has a first-order Si-Si peak at $\omega_0 = 520.5$ cm⁻¹,²³ and this transverse optical (TO) phonon mode (ω) can red-shift to lower wavenumbers in Si NCs due to two different physical principles. The first principle is based on a red-shift of the TO mode frequency ω to about 516-519 cm⁻¹ for the Si NCs due to the quantum confinement effect of small Si NCs (d < 10 nm, defined as "small" in the rest of this paper).²⁴ The average size of Si NCs can be calculated using this red-shift $\Delta \omega = |\omega - \omega_0|$. However, large Si NCs (d > 10 nm, defined as "large" in the rest of this paper) do not experience any significant quantum confinement effect and the first-order Si-Si peaks in Raman spectra are close to the bulk value of $\omega_0 = 520.5 \text{ cm}^{-1}$. Therefore the first-order TO mode cannot be used to determine the sizes of large NCs. The second physical principle for a red-shift of the 520.5 cm⁻¹ peak is due to a lattice expansion, for instance, induced by the thermal heating of Si NCs when the Raman spectroscopy is performed under intensive laser illumination. To reliably determine the size of the NCs, it is important to establish which of these physical principles are dominating the Raman spectrum for Si NCs embedded in a host material and free-standing Si NCs.

A detailed study is presented in this paper which demonstrates that depending on the measurement conditions (laser power), types of sample (free-standing versus embedded in host material) and size of Si NCs (small versus large), both physical principles can play an important role. Laser heating effects are observed in large free-standing Si NCs (with diameters of 20-50 nm), which have relatively poor thermal conductivity properties. It will be shown that this shift for the first-order Si-Si phonon line can be as huge as ~25.7 cm⁻¹ (ω ~494.8 cm⁻¹) and a width broadening as large as ~ 12.7 cm⁻¹. The temperature of large free-standing Si NCs (with diameters of 20-50 nm) under intense Raman laser illumination conditions is determined using the measured ratio of Anti-Stokes-to-Stokes (ASt-to-St) TO mode intensities. Pioneer experimental work on the laser-induced heating effect of the free-standing Si NCs has been reported by Poborchii et al.²⁵ In this paper, we will quantitatively compare the determined temperatures of freestanding Si NCs with the temperatures of Si NCs embedded in various types of matrixes, and the embedded NCs demonstrate moderate heating due to their good thermal conductivity. When the larger free-standing Si NCs are further heated, the thermal loss mechanism is dominated by blackbody radiation, as revealed by the detected background signals in the Raman spectra. The temperature dependence of the free-standing Si NCs on the illumination intensity allows us to successfully estimate the average size of free-standing Si NCs, as supported by HR-TEM analysis.

Experiments

Synthesis of Si NCs

The free-standing Si NCs studied in this paper were synthesized using the expanding thermal plasma chemical vapor deposition (ETP-CVD) technique, which has the advantages of incredible high production yield, high deposition rate, fabrication at room temperature, low cost, high purity and potential to integrate post-surface passivation treatment based on plasma processing.^{26, 27} The size of NCs is mainly determined by the residence time of Si species in the plasma downstream from the silane (SiH₄) injection ring to the substrate, and subsequently depends on parameters such as chamber pressure, gas flow, plasma power, etc.^{26, 27}

In this paper, three types of samples of Si NCs embedded in a host material have been studied as well: Si NCs in a hydrogenated amorphous silicon carbide (a-SiC:H) matrix, Si NCs in a hydrogenated amorphous silicon (a-Si:H) matrix, generally referred to as hydrogenated nano-crystalline silicon (nc-Si:H), and Si NCs in a hydrogenated silicon-oxide (a- SiO_x :H), often referred to as nano-crystalline silicon-oxide (nc-SiO_x:H). Plasma enhanced chemical vapor deposition (PECVD) was utilized to fabricate these three types of samples. Si rich a-SiC:H thin film was deposited and Si NCs were formed in the a-SiC:H matrix after a 1000 °C post annealing treatment for 1 hour in nitrogen (N2). In contrast, nc-Si:H were deposited directly by PECVD using very high frequency (VHF, 40.68 MHz) power of 40 W (over an area 10 cm \times 10 cm) at a low substrate temperature of 200 °C. The SiH4 gas is typically highly diluted by hydrogen (H₂) gas, which initiates the formation of crystalline grains during the film growth. The nc-SiO_x:H films were directly deposited by PECVD using radio frequency (RF, 13.56 MHz) power of 10 W at a low substrate temperature of 200 °C. The gas mixture is similar to the nc-Si:H conditions with an additional dilution of carbon dioxide (CO₂) gas, which results in an a-SiO_x:H tissue around the Si NCs.

Morphology of Si NC films

A photograph of the free-standing Si NCs material on a piece of Corning glass substrate is shown in Fig. 1 (a), from which we can see that the deposited brown-colored material is quite homogeneous on a scale of several centimeters (cm). The porous films of Si NCs were analyzed by SEM. Fig. 1 (b) shows a cross-sectional image of the Si NCs film as thick as ~10 μ m. Note that this layer was deposited by running the ETP-CVD for 1 second (s). Figs. 1 (c) and (d) are the top-view images of the film with low and high magnification respectively, and show that the brown powder has a high porosity.



Fig. 1 A photograph of film of the Si NCs material (a), SEM images of the cross-section (b) for the estimation of deposition rate, and from the top-view with a smaller (c) and a larger (d) magnification.

HR-TEM was employed to observe the size and morphology of the NCs at larger magnifications. The Si powder was peeled off from the substrate and distributed in the ethanol solution. Then

the Si NCs suspension was dropped onto a copper grid precoated with a holey carbon film. The copper grid was transferred into the JEM-2100F filed emission HR-TEM with an operating voltage of 200 kV. The HR-TEM images show two typical sizes for the Si NCs, i.e. small Si NCs in Fig. 2 (a) and large Si NCs in Fig. 2 (b). In the HR-TEM image in Fig. 2 (a), many dense dots are shown clearly in the field of view. These small grains are no other than Si NCs, as apparently shown by the contrast difference between Si NCs and the background. This shows that small Si NCs were formed and crystalized in the hot plasma. Well-isolated Si NCs with clear lattice fringes can be observed, while some surrounding Si tissue without lattice fringes remain in the amorphous state. It can be estimated that most of the small Si NCs have a diameter of 3-4 nm and the local density in the HR-TEM image is 4.0×10^{18} cm⁻³. Notice that these small NCs were collected on the substrate spots which are exactly below the holes in the SiH₄ injection ring. Therefore we believe that these small NCs were formed in the plasma beam and directly deposited on the substrate. However, free-standing larger NCs (diameter of dozens of nanometers) are also observed, as shown in Fig. 2 (b). These large NCs were collected from the other areas on the substrate. They have a larger average diameter due to the recycling from the back ground volume into the plasma beam.^{26, 27} The large NCs are regular spheres, with native silicon oxide coating around it. Summarized, this bimodal size distribution from a typical sample is a result of the NCs deposited directly from the plasma beam (2 nm < d < 10 nm) and recycling of NCs from the background volume into the plasma beam (20 nm < d < 50 nm).^{26, 27} By varying the amount of SiH₄ gas flow from 230, 420 to 600 sccm (standard cubic centimeter per minute, other depositions parameters were fixed), 3 samples of free-standing Si NCs were deposited with different size distributions. The HR-TEM analysis confirmed that these sample have an average size for the large NCs of 27.2±6.4 nm, 34.7±16.2 nm and 41.3±19.0 nm, respectively. The bimodal size distribution makes the ensembles of Si NCs studied in this paper unique in reference to typical Si NCs studied in literature that have sizes smaller than 12 nm.²⁸⁻³⁴



Fig. 2 HR-TEM images of the small Si NCs embedded in an a-Si:H matrix collected from the substrate below the holes in the SiH₄ injection ring in ETP-CVD (a) and the large free-standing Si NCs collected from the other areas of the sample (b).

The morphology of nc-Si:H films deposited by PECVD is similar to the small NCs in Fig. 2 (a), and these Si NCs are also

embedded in an a-Si:H matrix. The Si NCs in an a-SiC:H matrix or nc-SiO_x:H look similar as the nc-Si:H material, but they are embedded in the a-SiC:H and a-SiO_x:H matrix respectively.³⁵

Raman laser heating of Si NCs

Raman spectroscopy was performed by Renishaw inVia Micro-Raman microscope immediately after unloading the Si NCs sample from the ETP-CVD chamber. The 100× lens sharply focused the visible light ($\lambda = 514$ nm) from an argon (Ar) ion laser on the samples. The estimated beam diameter of the spot on the sample is ~4 µm. The intensity of the laser power can be varied by switching between filters having various transmissions (e.g., 1%, 5%, 10%, 50% and 100%). The laser power was measured using a handheld power meter (±8% accuracy). Under optimal focused conditions, the penetration depth in bulk c-Si of the light from the Ar ion laser is ~762 nm. Consequently, the penetration depth is deeper than 762 nm in porous samples of free-standing NCs.

A conventional Raman setup is equipped with high-pass filters, which only allows the measurement of the Stokes (St) peak and blocks the anti-Stokes (ASt) peak $\omega_{0,ASt} = -520.5$ cm⁻¹. However, the amplitude of the ASt TO mode is sensitive to the temperature of the NCs.^{31, 36} To determine the temperature of the Si NCs, the ASt peak should be measured as well. Sharp band-stop filters at the excitation wavelength (514 nm in this work) are used to simultaneously measure the ASt and St peaks. Therefore, two same Notch filters (Model NF03-514E-25, Laser 2000 Benelux CV Co.) were installed in our Renishaw Micro-Raman setup to fully filter out the excitation wavelength.

Results and discussions

Under mild laser illumination conditions, the first-order Si-Si mode peak of small Si NCs (2 nm < d < 10 nm) in the Raman spectrum is lower by a few wavenumbers in reference to the number observed for bulk c-Si $\omega_0 = 520.5$ cm⁻¹, as observed by many others.^{5, 23, 37-39} In general this observation is attributed to phonon confinement, due to the presence of small NCs embedded in the hydrogenated amorphous Si (a-Si:H) environment (Fig. 2 (a)). Assuming that this shift can be fully attributed to quantum confinement effect, the average small NCs size can be estimated from the anharmonic Raman softening according to this formula⁴⁰

$$d = 2\pi \left(\frac{C}{\Delta\omega}\right)^{\frac{1}{2}} \tag{1}$$

Here, *d* (nm) stands for the diameter of the average NCs size, and C = 2.24 nm² cm⁻¹, which is a constant for Si material. $\Delta \omega$ is the absolute wavenumber (cm⁻¹) difference between ω_0 and the measured ω for Si NCs, i.e., $\Delta \omega = |\omega_0 - \omega|$. The average size can be determined from Eq. (1). Tensile stress induced effects were also reported to cause the red-shift.^{30, 41} Tensile stress can be created if the Si NCs are significantly heated by laser absorption. Therefore, the above method works only when Si NCs exposed to a low laser intensity and the materials have a good thermal conductivity to guarantee no significant heating of the NCs.

In our work, it will be shown that the large free-standing Si NCs can be significantly heated by intense laser illumination,

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and the quantum confinement effect is no longer the dominant mechanism for the red-shifts of the first-order Si-Si mode peak. The large (20 nm < d < 50 nm) Si NCs are free-standing and therefore they have poor thermal conductivity properties.³² The large NCs are hardly physically interconnected and the heat transfer is ineffective. During the measurements on such freestanding Si NCs with poor thermal conductivity, an interesting huge ($\Delta \omega > 10 \text{ cm}^{-1}$) red-shift and even melting of the Si NCs can be observed when they are exposed to an intensive and well-focused laser. Fig. 3 (a)-(d) are pictures taken by the Philips SPC 900NC PC camera installed above the lens in Renishaw Raman setup. The pictures show a sample after the measurements at four different laser illumination intensities and durations. In the employed measurement procedure, the freestanding Si NCs were intentionally and repeatable heated on the same spot. Fig. 3 (a) corresponds to the image of the Si NCs after a 10 s exposure to laser with a power of 69.3 μ W. The material in the spot size is almost unaffected compared to the as-deposited samples. When the laser power raises to $346 \mu W$, the sample is clearly affected by the exposure to the laser light. An affected zone with a diameter of ~4-6 µm appears in the illumination spot, as illustrated in Fig. 3 (b). This means that the layer of Si NCs in the spot is heated up to the extent that the Si NCs are melted. This melted Si "liquid" diffuses partly out of the illumination spot. If the laser power further increases to 602 µW, the melting zone around the laser spot gets larger for an illumination exposure of 10 s, as shown in Fig. 3 (c). In the following steps, even if this process is repeated for 10 times, i.e. 100 s in total, the affected zone remains the same size and shape as Fig. 3 (c). What seems interesting is that if the same spot is continuously illuminated by $602 \mu W$ laser for 100 s only once, a volcano-shaped zone with a diameter of $\sim 8 \ \mu m$ circle and a $\sim 15 \,\mu m$ tail are observed, as shown in Fig. 3 (d). Poborchii et al. reported that this volcano-shape is caused by the "wind" due to the simultaneously presence of a very high temperature gradient and decreasing absorption coefficients.² However, this does not directly explain the difference between effective intermittent exposure of 100 s resulting in less melting of Si NCs compared to the uninterrupted exposure of 100 s. This indicates that due to the poor thermal conductivity of the free-standing Si NCs, it takes more than 10 s to reach a quasithermal equilibrium in the layer of Si NCs. These measurements demonstrate that light absorption by the freestanding Si NCs under the employed laser powers can easily result in temperatures as high as the melting point of Si NCs.



Fig. 3 In-situ photos of Si NCs after 10 s exposure of laser with a power of 69.3 μ W (a), the material remains unaffected compared to the as-deposited samples; an affected zone with a diameter of ~5 μ m appears in the illumination spot after 10 s exposure of laser with a power of 346 μ W (b); the Si "liquid" diffuses larger after 10 s exposure of laser with a power of 602 μ W (c), and the sample keeps unchanged if this is repeated 10 times; a volcano-shaped affected zone is formed after 100 s continuous exposure of laser with a power of 602 μ W (d).

At the first sight, it might be surprising that these Si NCs can melt (melting point of c-Si is 1687 K at standard test conditions) when they are exposed to a power that is less than 1 mW. However, if we assume the laser power of 602 μ W is equally distributed in a spot with a $d_L \approx 4 \mu m$ diameter, the average power density is 4.79×10^8 W m⁻², which is equal to 47900 Suns in air mass 1.5 (AM 1.5, 1000 W m⁻²) conditions!

In order to estimate the temperature of the hot large Si NCs before melting under intensive illumination, we heated the Si NCs sample step by step by increasing the Ar ion laser power from 3.3 to 16.5, 33, 165 and 330 μ W. Fig. 4 (a) shows that St TO mode peak at 520.5 cm⁻¹ red-shifts to 518, 517, 500 and even 495 cm⁻¹ respectively. In addition, the full width at half maximum (FWHM) is widened greatly from 8.8 to 8.9, 9.5, 17.1 and 21.5 cm⁻¹ respectively. The amplitude of the measured Ast TO mode at -520.5 cm⁻¹ increases significantly with the enhancement of the laser power. To be more precise, both the ASt and St peaks increase significantly with laser power, however the ASt peaks relatively increases more than the St peaks. The ASt peaks show a red-shift with the increasing laser power as well. To quantify the heating effects by the absorption of the laser light, we use the ratio of the ASt-to-St TO mode intensities to determine the temperature of the Si NCs.⁴² According to the studies reported in literature,^{31, 33, 36} the temperature of Si NCs can be estimated by

$$\frac{I_{ASt}}{I_{St}} = \exp\left(\frac{E_R}{kT}\right) \tag{2}$$

Here, I_{ASt}/I_{St} is the ratio of the Anti-Stokes-to-Stokes (ASt-to-St) TO mode intensities, k is the Boltzmann constant, E_R is the phonon energy (i.e., $E_R = hc/\lambda_{\text{excitation}} - hc/\lambda_{\text{emission}} = hc \cdot \omega \cdot 10^{-7}$), h and c are the Planck constant and light speed, respectively. ω is the Raman peak shift frequency expressed in cm⁻¹. T, the temperature of the Si NCs during the laser heating, can then be determined from Eq. (2).

The results in Fig. 4 (a) reflect that the ratio of I_{ASt}/I_{St} increases with laser power, which means the large Si NCs were heated up by the absorption of the laser energy. The power of the probe laser is indicated on the left side of each curve. On the right side, the calculated temperature using Eq. (2) is presented. The results show that the free-standing Si NCs can be heated from room temperature to as high as ~953 K, when the laser power increases 100 times from 3.3 to 330 µW (~263-26300 Suns). By further analyzing the data shown in Fig. 4 (a), we find that the temperature of the illuminated free-standing Si NCs increases with the wavenumber enhancement of the red-shifts $\Delta \omega$, and simultaneously with the peak widening of the TO mode St peak as well as shown by the FWHM enhancement in Fig. 4 (b). This demonstrates that both $\Delta \omega$ and FWHM are determined by the temperature of the Si NCs, and agrees with the findings in literature.^{28, 29, 43}



Fig. 4 Anti-Stokes and Stokes TO mode peaks shift in the Raman spectra of the larger free-standing Si NCs with increasing Raman laser illumination (a). The TO mode red-shift and the full width at half maximum (FWHM) of the TO mode of Stokes peak widening with the temperature enhancement (b). The dashed lines are guides for the eyes.

The question that remains is whether large Si NCs embedded in a host matrix can be significantly heated under the same illumination conditions as well? Therefore, the same laser heating Raman spectroscopy was done on the samples of Si NCs embedded in a matrix, such as Si NCs in a-SiC:H, nc-Si:H and nc-SiO_x:H. Fig. 5 shows the temperatures of the Si based materials when heated by the Ar ion laser. As shown the freestanding Si NCs can be heated to temperatures up to ~953 K. However, it is not easy to heat the other materials when they are embedded in a matrix. It demonstrates that the interconnection between the surfaces of the large Si NCs and the tissue of the host matrix results in good thermal conductivity. For example, Si NCs in an a-SiC:H matrix material (blue triangles in Fig. 5) can be heated up to ~375 K illuminated by 330 μ W. This temperature is slightly higher than for the Si NCs in nc-Si:H and nc-SiO_x:H.

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Fig. 5 Laser heating effects of several Si NCs based materials. Free-standing Si NCs are much easier to be heated than Si NCs embedded in various matrixes illuminated by intensive laser. The lines are guides for the eyes.

This comparison shows the unique properties of the large freestanding Si NCs. The fact that they are hardly physically interconnected limits the heat transfer between the particles. Another possible route for the free-standing particle to lose its heat is through the blackbody radiation.^{34, 44} We have observed signatures of such blackbody radiation from hot free-standing Si NCs. Fig. 6 shows the Raman spectra of a sample of freestanding Si NCs under large laser powers of 330 or even 660 μ W. The presence of the St peaks in the spectra shows that the sample still contains solid Si NCs. However, the sample might contain liquid Si phase as well. Furthermore, the red-shift is enormous $\Delta \omega \sim 30$ cm⁻¹ (i.e., $\omega \sim 490$ cm⁻¹). The background signals in the Raman spectra have a large tilt that even overrules the amplitude of the measured St peaks. Therefore it is not possible any more to accurately determine the temperature using Eq. (2).



Fig. 6 Raman spectra of the large free-standing Si NCs under intensive (I = 330 and 660 μ W) laser power.

We claim that the background tilt reflects blackbody radiation of the large Si NCs.³⁴ The temperature of the large Si NCs gets so high that the intensity of blackbody radiation in the spectral range around the Raman laser 519 – 542 nm (corresponds to 200 cm⁻¹ $\leq \omega \leq 1000$ cm⁻¹) is similar or higher than that of the

St Raman peak. According to Planck's Law, the blackbody radiation of an object can be described as

$$B_{T}(\lambda) = 2hc^{2}\lambda^{-5} \left[\exp(\frac{hc}{\lambda k_{\rm B}T}) - 1 \right]^{T}$$
(3)

where B denotes the wavelength-dependent blackbody spectral radiance at a certain temperature, h the Planck constant, c the speed of light in the medium and $k_{\rm B}$ the Boltzmann constant. λ is the wavelength (nm) and can be transformed into wavenumber (cm⁻¹) in Fig. 6. The green and orange dashed curves in Fig. 6 are the fitting curves of Eq. (3) multiplied by a coefficient that can compensate the difference between the radiance value and the Raman intensity counts. It is interesting to observe that the blackbody radiation curves fit the slopes in the Raman intensity background (excluding the St TO mode peaks) well. The simulations of the Planck's Law give temperatures in the order of 1015±5 and 1005±5 K under the 330 and 660 μ W laser illumination, respectively. It has to be noted that the laser light has a limited penetration depth in to the porous silicon film. As a result the large Si NCs at the surface will be heated more than the ones sub-surface within the penetration depth. Therefore the measured temperature should be interpreted as an average temperature over the temperature gradient. Nevertheless, the average temperature is close to the temperature of ~953 K before significant melting of Si NCs occurs as can be concluded from Figs. 3 and 4. This implies that significant fraction of Si NCs can be melted at extreme intensive illumination conditions. The found temperatures of 1005-1015 K indicate that the melting temperature of free-standing Si NCs is much lower than for bulk c-Si (1687 K at standard test conditions). These melting temperatures of free-standing Si NCs are close to values reported in various other studies.⁴⁵⁻⁴⁷ An additional effect is that the melted free-standing Si NCs aggregate and as a consequence they significantly improve the thermal conductivity. In the presence of a liquid Si phase, the NCs cannot be heated up much more. Although the laser intensity is doubled from 330 to 660 µW in Fig. 6, the temperature of the mixed phase of Si liquid and NCs does not increase anymore.

Another experiment was performed to test whether the Raman laser heating effects for large free-standing Si NCs were reversible and whether the morphology of the NCs was modified after the laser illumination. After the step-by-step increasing of the laser power on the same spot on the sample (results shown in Fig. 4), the laser power was decreased step by step. The temperature at every laser power (exposure time of 10 s) was determined again by the measured ratio of ASt-to-St TO mode intensities using Eq. (2). The results are presented in Fig. 7. The TO mode positions and shapes during the "cooling" phase (data not shown here) are very similar to those illustrated in Fig. 4 at the same illumination conditions. This means that after reaching the highest temperature not all Si is melted and Si NCs are still present in the layer. It can be noticed that during the "cooling" phase, the Si material can still get reasonably heated. However, it is also exemplified that the NCs left at the same spot in the "cooling" phase cannot reach the same temperature as in the initial "heating" phase. At an illumination power of 165 μ W the temperature of the Si NCs in the "heating" phase is ~762 K, while in the "cooling" phase it is significantly lower, ~600 K. This temperature difference implies that the thermal conductivity of the ensemble of freestanding Si NCs has improved after going through the "heating" phase. A possible explanation could be that the

aggregation of Si NCs or some melting of Si NCs has improved the physical interconnection of the NCs. We can conclude that the laser heating effects are to a large extent reversible, but the nature of the porous Si NCs based layer gets slightly modified under intensive laser induced heating.



Fig. 7 Temperature comparison between the "heating" and "cooling" phases on the same spot of Si NCs materials.

So far, we have demonstrated that large free-standing Si NCs can be significantly heated by laser illumination due to the poor thermal conductivity of these layers. In addition, we have observed that one of the heat loss mechanisms is by blackbody radiation. If blackbody radiation would be the dominant mechanism for free-standing NCs to lose its thermal energy, the equilibrium temperature under laser illumination should depend on the size. In the final part of this paper, we will study whether this is indeed the case. A simplified model is established for this study. We assume that thermal conductivity between the neighboring Si NCs can be neglected and the laser penetration depth in c-Si (~762 nm) is much larger than the typical average diameter (d) of the Si NCs ($20 \le d \le 50$ nm). The laser intensity I is the laser power P divided by the laser spot size on the sample $I \sim P/(\pi d_L^2/4)$ with $d_L \approx 4 \ \mu m$ the diameter of the spot size. The power absorbed by one single NCs (P_{abs}) is proportional to the NC volume and can be estimated by $P_{\rm abs} \sim$ $(\pi d^3/6) \cdot \alpha \cdot P/(\pi d_{\rm L}^2/4) \sim P d^3$ with α the absorption coefficient of Si at 514 nm. The radiation at thermal equilibrium from one single NC (P_{irr}) is estimated by the Stefan-Boltzmann Law P_{irr} ~ $\sigma T^4 \cdot \pi d^2 \sim T^4 d^2$, where σ stands for the Stefan-Boltzmann constant. In thermal equilibrium, the thermal generation and thermal losses of the Si NCs are equal, i.e., $P_{abs} \approx P_{irr}$. Under these conditions T, d, and I are related for each specific sample like:

$$T \sim d^{1/4} P^{1/4}(T,d)$$
 (4)

So in the case that blackbody radiation is dominant, we can expect a relation between T and P given by Eq. (4). We have measured this dependence for three samples of free-standing NCs with different average diameters for the large particles $d = 27.2\pm6.4$, 34.7 ± 16.2 and 41.3 ± 19.0 nm. This data is presented in Fig. 8. The results confirm that temperature can be simulated with a $T \sim P^{1/4}$ dependence (for each specific sample, the average diameter d is a fixed value). This implies that indeed the thermal conductivity of the large Si NCs can be neglected compared to thermal radiation. Furthermore, Eq. (4) predicts that the slope of the $T \sim P^{1/4}$ dependence is increasing with average size of the large Si NCs. This is in agreement with the results shown in Fig. 8. The larger NCs (sample with d = 41.3

nm) are easier to be heated than the smaller ones (samples with d = 34.7 and 27.2 nm) when the same amount of laser power is used. The trend in Fig. 8 additionally explains why the small Si NCs (if they would be fully free-standing) do not significantly heat up. Considering small Si NCs with a diameter of 4 nm, the Si NCs would only heat up to ~370 K for the highest laser power depicted in Fig. 8.



Fig. 8 Temperatures determined from the Raman laser heating effects show a dependence on the average sizes of free-standing Si NCs. $T \sim P^{1/4}$ fitting of each sample is illustrated by the dashed curves.

Conclusions

In this paper, the laser induced heating effects are studied in bimodal size-distributed Si NCs using Raman spectroscopy. The Si NCs were fabricated by ETP-CVD, and the morphology of NCs were characterized by SEM and HR-TEM. Under low intensity illumination at the wavelength of 514 nm, the typical quantum confinement effects for small Si NCs (diameter of 2-10 nm) are observed. The TO mode of the first order Si-Si peak red-shifts a few wavenumbers in reference to the bulk c-Si at 520.5 cm^{-1} due to the quantum confinement effect. The average diameter of these small Si NCs can be estimated according to the amount of this red-shift. However, if the free-standing Si NCs are illuminated by intensive Ar ion laser, the thermal heating effects of the large Si NCs (diameter of 20-50 nm) become the dominant mechanism for the TO mode shift in the Raman spectrum. A huge red-shift up to ~ 25.7 cm⁻¹ and a peak widening of ~ 12.7 cm⁻¹ is observed as a result of the lattice expansion in Si NCs. The melting of large Si NCs illuminated by intensive laser is monitored by the camera installed in the Raman setup. The temperatures of the heated Si NCs are determined using the ratio of Anti-Stokes-to-Stokes TO mode intensities. The large free-standing Si NCs can be heated as hot as ~953 K by a well-focused laser with a power of 330 μ W. In contrast, Si NCs in various matrixes were fabricated by PECVD. These samples can hardly be heated using the same amount of laser power due to their good thermal conductivity. If the large free-standing Si NCs are further heated, the intensity of the blackbody radiation in Raman spectrum starts to compete with that of the TO mode. When the materials are in the mixed phase of liquid and solid NCs, the temperatures are estimated to be in the range of 1005-1015 K according to Planck's Law. The laser heating effects are confirmed to be reversible to a large extent, but the nature of the material is slightly modified after intensive laser illumination. A simplified

model of the heating effects of large Si NCs is established to study the size dependence of the heated free-standing Si NCs with an increasing laser power.

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Notes and references

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Paper

Raman Study of Laser Induced Heating Effects in Free-Standing Silicon Nanocrystals

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Table of contents

(20-30 words, 8cm * 4cm figure)

The size-dependent temperatures of free-standing Si nanocrystals under laser illumination are determined by Raman spectroscopy.

